

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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- **Dual Output**
- SIP or DIP Package
- **Industry Standard Pinout**
- 1000 VDC Isolation
- -40 °C to +85 °C Operation
- MTBF >1.1 MHrs
- 3 Year Warranty

Specification

Input

Input Voltage Range

Input Reflected Ripple Current

Input Reverse Voltage Protection

- Nominal ±10% (5)
- 20 mA pk-pk (through 12 µH inductor 5 Hz to 20 MHz)
- None

Output

Output Voltage

Minimum Load

Line Regulation

Load Regulation

 None⁽⁶⁾ • 1.2%/1% ∆ Vin

See table

10% 20-100% load change (3.3 V models ±20%)

Setpoint Accuracy

Ripple & Noise

• 75 mV pk-pk max, 20 MHz bandwidth

Temperature Coefficient • 0.02%/°C

• ±100 µF Maximum Capacitive

Load

General

Efficiency

See table

Isolation Voltage

• 1000 VDC minimum 10°Ω

Isolation Resistance **Isolation Capacitance**

· 60 pF typical

Switching Frequency

Variable, 80 KHz typical

MTBF

>1.12 MHrs to MIL-HDBK-217F

at 25 °C, GB

Environmental

Operating Temperature • -40 °C to +85 °C

Storage Temperature

• -40 °C to +125 °C

Case Temperature

100 °C max

Cooling

· Convection-cooled

Notes

- Replace 'S' in model number with 'D' for DIP package. 1.
- SIP 48 Vin models, dimension is 0.28 (7.20) max.
- DIP 48 Vin models, dimension is 0.27 (6.88) max.
- Outputs power-trade.
- For 48 V models a 10 μ F capacitor is required between +Vin and -Vin pins.
- 6. Operation at no load will not damage unit but it may not meet all specifications.
- All dimensions in inches (mm)
- Pin pitch tolerance: ±0.014 (±0.35)
- Case tolerance ±0.02 (±0.5)
- 10. Weight: SIP 0.006 lbs (2.6 g), DIP 0.005 lbs (2.3 g)



Mechanical Details



